

HCW65D20D1QA

eSiC Automotive Silicon Carbide Schottky Diode

650V, 20A

Description

The 650V eSiC is an advanced Power Master Semiconductor's silicon carbide diode family.

This technology combines the benefits of excellent low capacitive charge and robustness.

Consequently, the eSiC family is suitable for application requiring high power efficiency.

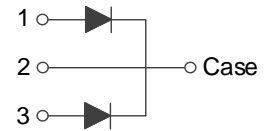
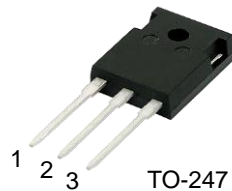
Applications

- OBC (On Board Charger)
- DC/DC Converter for EV/HEV
- Wireless Charger

Features

V_{RRM}	I_F	$T_{J,max}$	Q_C
650 V	10 / 20 A	175 °C	31 nC

- No reverse recovery current
- Low forward voltage
- 175°C Max junction temperature
- High surge current capability
- Switching behavior independent of temperature
- AEC Q101 Qualified
- Pb-Free, Halogen Free and RoHS compliant



Absolute Maximum Ratings (Per Leg / Device & Per Leg, $T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	650	V
I_F	Forward Current	$T_C=136^\circ\text{C}$ 10 / 20	A
$I_{F,SM}$	Non-Repetitive Forward Surge Current	$T_C=25^\circ\text{C}, t_p=10\text{ ms}$	50
		$T_C=150^\circ\text{C}, t_p=10\text{ ms}$	42.5
$I_{F,Max}$	Non-Repetitive Peak Forward Current	$T_C=25^\circ\text{C}, t_p=10\text{ us}$	424
		$T_C=150^\circ\text{C}, t_p=10\text{ us}$	360
I^2dt value	$\int I^2 dt$	$T_C=25^\circ\text{C}, t_p=10\text{ ms}$	12.5
		$T_C=150^\circ\text{C}, t_p=10\text{ ms}$	9
P_{tot}	Power Dissipation	$T_C=25^\circ\text{C}$ 75	W
T_J, T_{STG}	Operating Junction and Storage Temperature	-55 to +175	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.(Per Leg / Per Device)	2.0 / 1.0	$^\circ\text{C/W}$

Package Marking and Ordering Information

Part Number	Top Marking	Package	Packing Method	Quantity
HCW65D20D1QA	HCW65D20D1QA	TO-247	Tube	30 units

Electrical Characteristics (Per Leg, $T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_F	Forward Voltage	$I_F=10\text{ A}, T_C=25^\circ\text{C}$		1.40	1.7	V
		$I_F=10\text{ A}, T_C=175^\circ\text{C}$		1.55	-	
I_R	Reverse Current	$V_R=650\text{ V}, T_C=25^\circ\text{C}$		-	100	μA
		$V_R=650\text{ V}, T_C=175^\circ\text{C}$		-	300	
Q_C	Total Capacitive Charge	$V_R=400\text{ V}, T_C=25^\circ\text{C}$		31		nC
C	Total Capacitance	$V_R=1\text{ V}, f=100\text{ kHz}$		505		pF
		$V_R=400\text{ V}, f=100\text{ kHz}$		49		
E_C	Capacitance Stored Energy	$V_R=400\text{ V}, T_C=25^\circ\text{C}$		4.6		μJ

Typical Performance Characteristics (Per Leg)

Figure 1. Power Derating

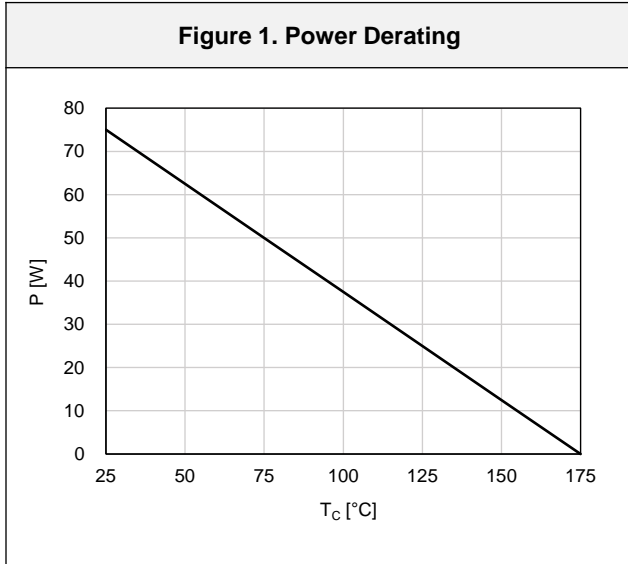


Figure 2. Current Derating

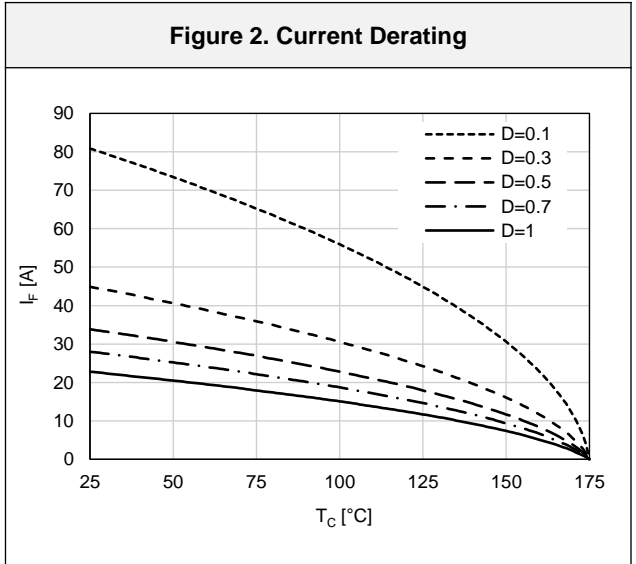


Figure 3. Forward Characteristics

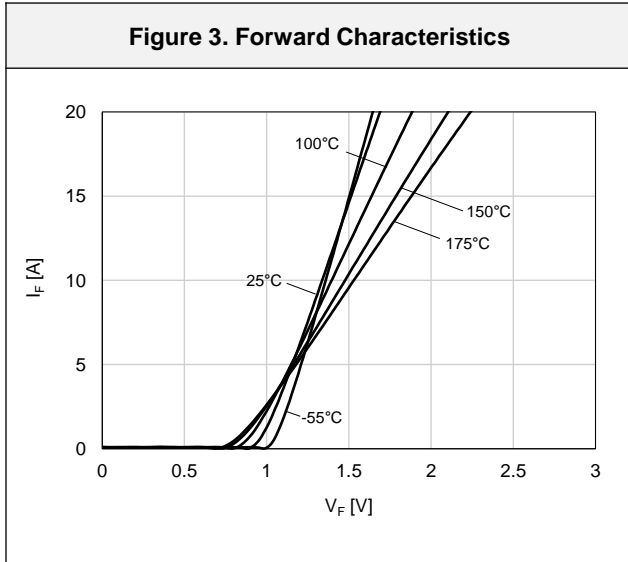


Figure 4. Reverse Characteristics

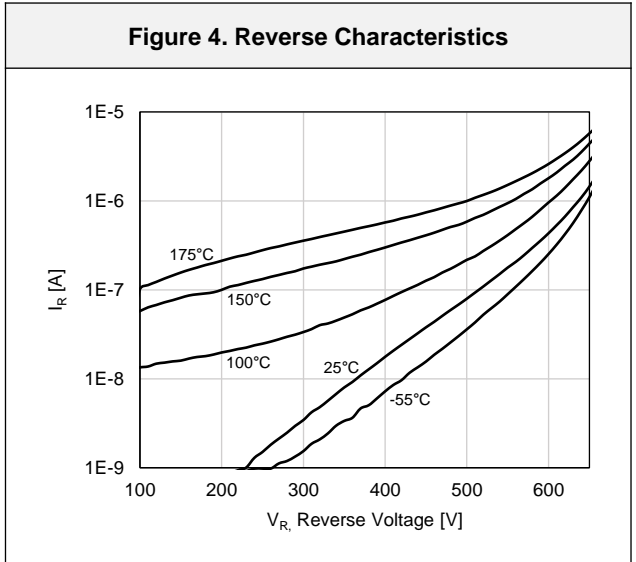


Figure 5. Capacitive Charge Characteristic

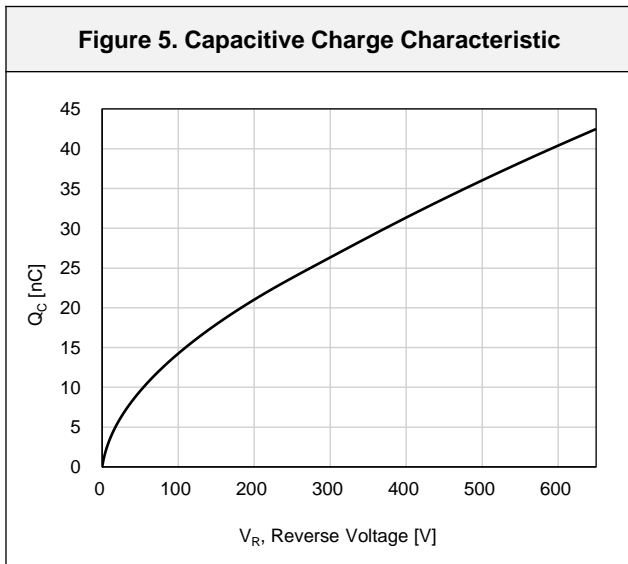
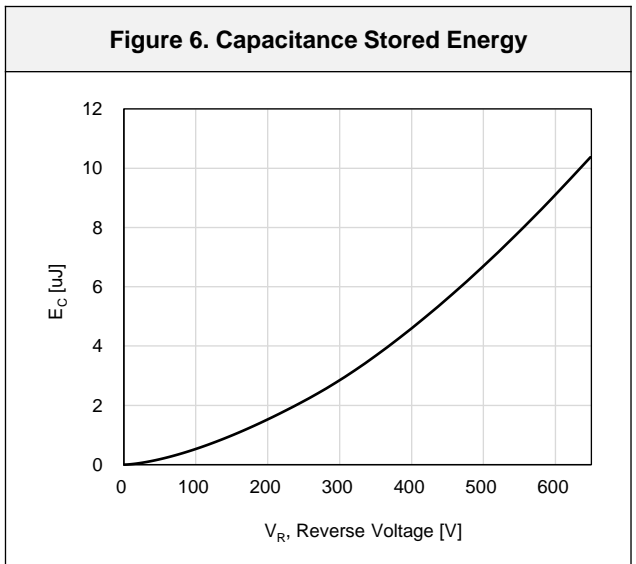


Figure 6. Capacitance Stored Energy



Typical Performance Characteristics (Per Leg)

Figure 7. Capacitance Characteristic

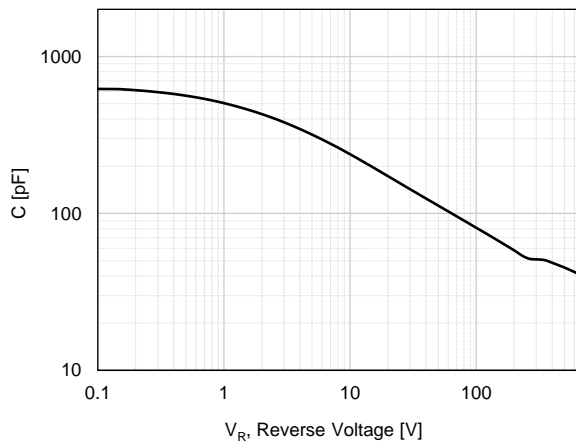
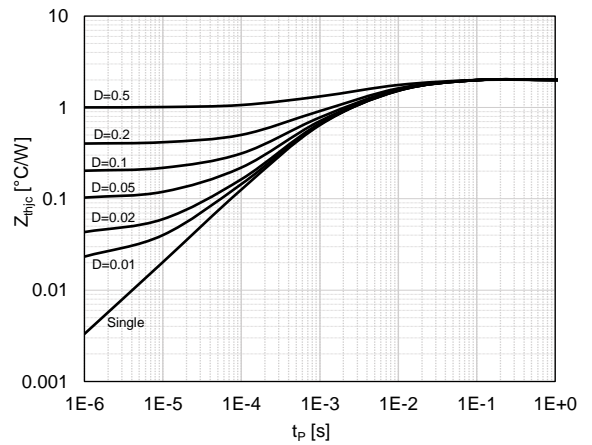
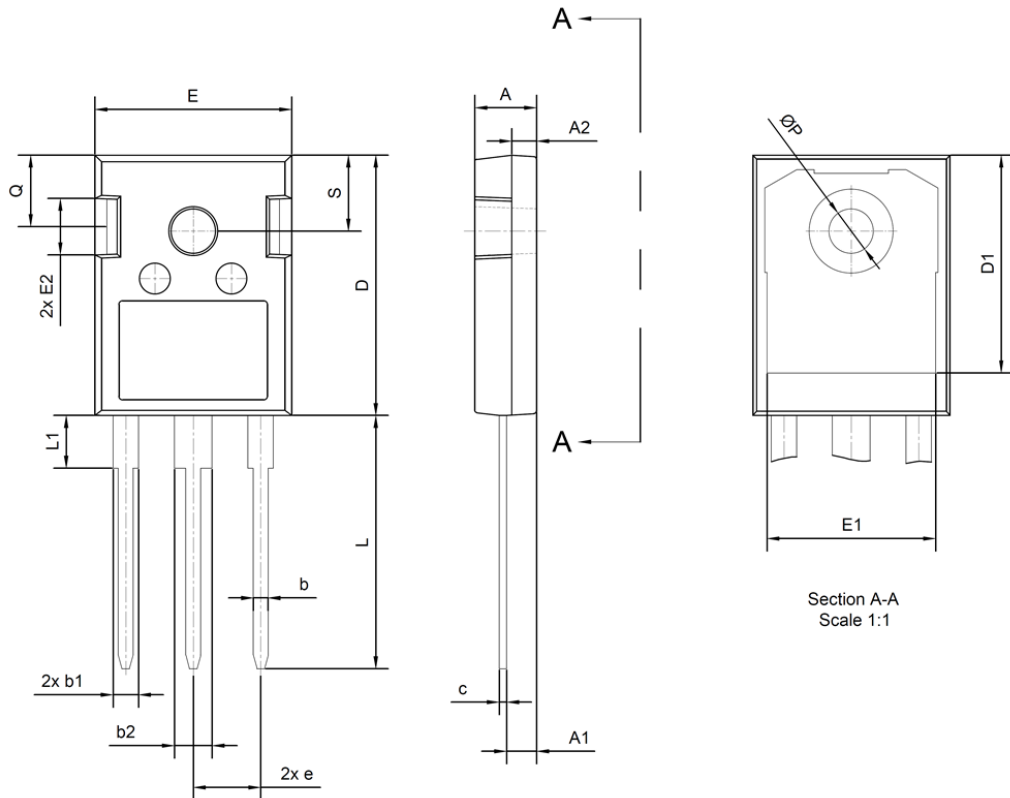


Figure 8. Transient Thermal Response Curve



Package Outlines

TO-247



Section A-A
Scale 1:1

SYMBOL	Common		
	DIMENSIONS MILLIMETER		
	MIN.	NOM.	MAX.
A	4.80	5.00	5.20
A1	2.29	2.42	2.54
A2	1.90	2.00	2.10
b	1.10	1.20	1.30
b1	1.91	2.06	2.20
b2	2.92	3.06	3.20
c	0.50	0.60	0.70
D	20.80	21.07	21.34
D1	17.23	17.63	18.03
E	15.75	15.94	16.13
E1	13.46	13.66	13.86
E2	4.32	4.58	4.83
e	5.46 BSC		
L	19.85	20.05	20.25
L1	4.05	4.27	4.48
ØP	3.56	3.61	3.66
Q	5.38	5.79	6.20
S	6.15 BSC		